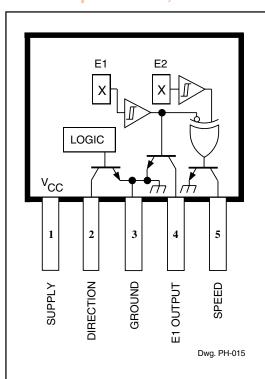
3421 AND 3422

Data Shee **27650**.1

PRELIMINARY INFORMATION (subject to change without notice) September 6, 2000



Pinning is shown viewed from branded side.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V _{CC} 18 V
Magnetic Flux Density, B Unlimited
Output OFF Voltage, V_{OUT} V_{CC}
Output Sink Current, I _{OUT} 30 mA
Package Power Dissipation,
P _D 500 mW
Operating Temperature Range, T _A
Suffix 'EKA'40°C to +85°C
Suffix 'LKA' -40° C to $+150^{\circ}$ C
Storage Temperature Range,
$T_S \dots -65^{\circ}C \text{ to } +170^{\circ}C$

HALL-EFFECT, DIRECTION-DETECTION SENSORS

The A3421xKA and A3422xKA Hall-effect, direction-detection sensors are a new generation of special-function integrated sensors that are capable of sensing the direction of rotation of a ring magnet. These transducers provide separate digital outputs that provide information on magnet rotation speed, direction, and magnet pole count. These devices eliminate the major manufacturing hurdles encountered in fine-pitch direction-detection applications, namely maintaining accurate mechanical location between the two active Hall elements. Here, the two Hall elements are photolithographically aligned to better than 1 µm, as contrasted with 100 µm or worse mechanical location tolerance when manufactured discretely. These highly sensitive, temperature-stable, magnetic transducers are ideal for use in digital-encoder systems in the harsh environments of automotive or industrial applications. The A3421xKA is a high-hysteresis device designed for low-resolution pulse counting while the A3422xKA is a high-sensitivity device optimized for use with high-density magnets.

The A3421xKA and A3422xKA monolithic integrated circuits contain two independent Hall-effect latches whose digital outputs are internally coupled to CMOS logic circuitry that decodes signal speed and direction. Extremely low-drift BiCMOS circuitry is used for the amplifiers to ensure symmetry between the two latches so that signal quadrature can be maintained. An on-chip voltage regulator allows the use of these devices from a 4.5 V to 18 V supply. Both devices have standard open-collector outputs; the logic operation of both devices is the same.

Two operating temperature ranges are provided; suffix 'E-' is for the automotive and industrial temperature range of -40°C to +85°C, suffix 'L-' is for the automotive and military temperature range of -40°C to +150°C. The 5-pin 'KA' SIP package provides a cost-competitive solution to linear magnetic sensing in harsh environments.

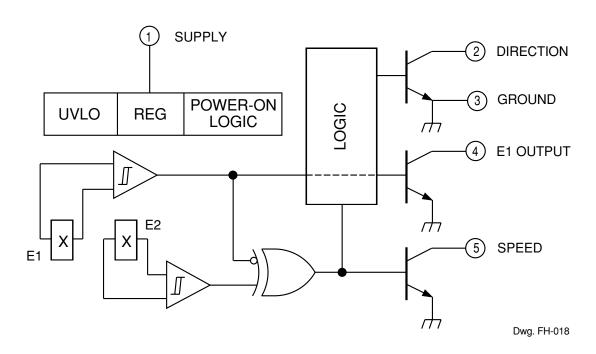
FEATURES

- Internal Direction-Decoding Circuitry
- Two Matched Hall Latches On A Single Substrate
- Superior Temperature Stability
- 4.5 V to 18 V Operation Electrically Defined Power-On State Under-Voltage Lockout

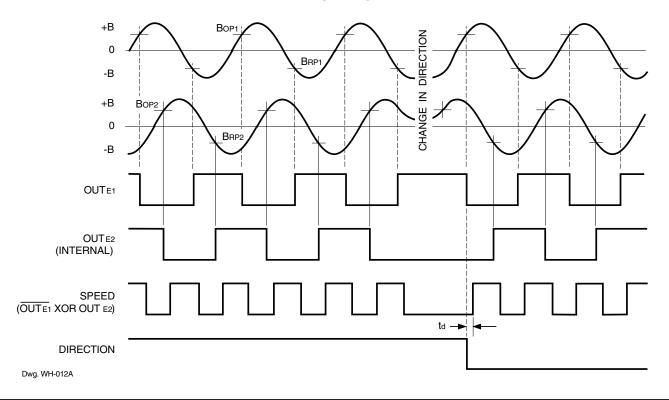
Always order by complete part number, e.g., **A3421EKA** .



FUNCTIONAL BLOCK DIAGRAM



TIMING DIAGRAM



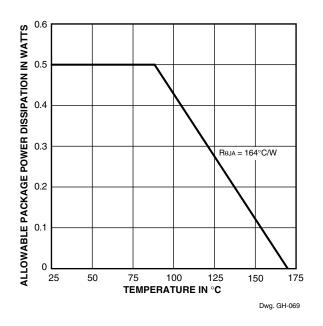


ELECTRICAL CHARACTERISTICS over operating temperature range.

			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Supply Voltage Range	V _{CC}	Operating, T _J < 165°C¹	4.5	_	18	V
Output Leakage Current	I _{OFF}	V _{OUT} = V _{CC} = 18 V	_	<1.0	10	μΑ
Output Saturation Voltage	V _{OUT(SAT)}	I _{OUT} = 20 mA	_	0.21	0.50	V
Power-On State	POS	$V_{CC} = 0 \rightarrow 5 \text{ V},$ $B_{RP1} < B < B_{OP1}, B_{RP2} < B < B_{OP2}$	OFF	OFF	OFF	_
Under-Voltage Lockout	V _{CC(UV)}	I_{OUT} = 20 mA, V_{CC} = 0 \rightarrow 5 V	_	3.5	_	V
Under-Voltage Hysteresis	V _{CC(hys)}	Lockout (V _{CC(UV)}) - Shutdown	_	0.5	_	V
Power-On Time	t _{po}	V _{CC} > 4.5 V	_	_	50	μs
Output Rise Time	t _r	$C_L = 20 \text{ pF}, R_L = 820 \Omega$	_	200	_	ns
Output Fall Time	t _f	$C_L = 20 \text{ pF}, R_L = 820 \Omega$	_	200	_	ns
Direction Change Delay	t _d	$C_L = 20 \text{ pF}, R_L = 820 \Omega$	0.5	1.0	5.0	μs
Supply Current	I _{cc}	V _{CC} = 8 V, All outputs OFF	5.0	9.0	18	mA

NOTES: 1. Maximum supply voltage must be adjusted for power dissipation and ambient temperature.

2. Typical Data is at $V_{CC} = 12 \text{ V}$ and $T_A = +25^{\circ}\text{C}$ and is for design information only.



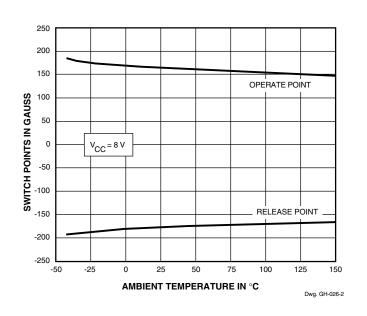
MAGNETIC CHARACTERISTICS over operating voltage range.

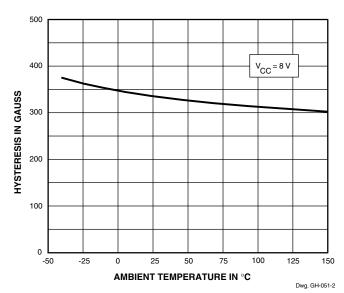
			A3421xKA			A3422xKA			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Operate Point	B _{OP}	T _A = -40°C	140	185	300	_	29	85	G
		T _A = +25°C	130	160	280	_	29	75	G
		T _A = Maximum	120	_	260	_	_	75	G
Release Point ³	B _{RP}	T _A = -40°C	-300	-190	-140	-85	-19	_	G
		T _A = +25°C	-280	-175	-130	-75	-18	_	G
		T _A = Maximum	-260	_	-120	-75	-16	_	G
Hysteresis	B _{hys}	T _A = -40°C	280	375	_	10	48	_	G
		T _A = +25°C	260	335	_	10	46	_	G
		T _A = Maximum	240	_	_	10	_	_	G
Operate Differential		B _{OP1} - B _{OP2}	_	_	±80	_	_	±60	G
Release Differential		B _{RP1} - B _{RP2}	_		±80	_		±60	G

- NOTES:1. Magnetic flux density is measured at most sensitive area of device, nominally located 0.014" (0.37 mm) below the branded face of the package.
 - 2. Typical Data is at V_{CC} = 12 V and T_A = +25°C and is for design information only.
 - 3. As used here, negative flux densities are defined as less than zero (algebraic convention).

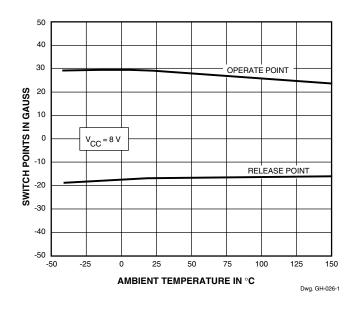


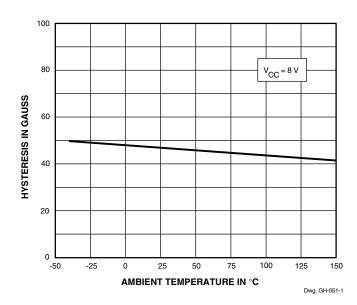
TYPICAL A3421xKA CHARACTERISTICS



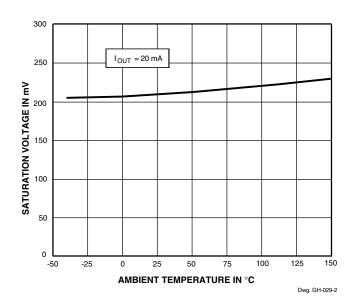


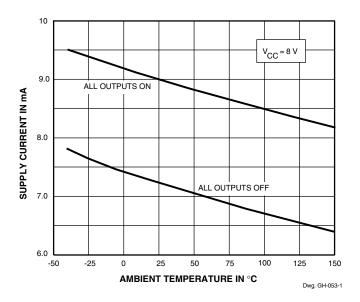
TYPICAL A3422xKA CHARACTERISTICS

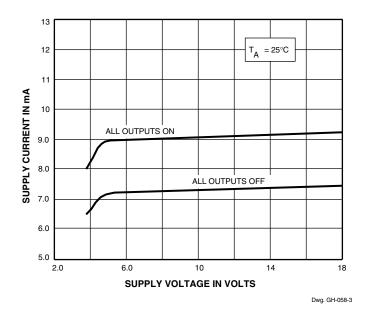




TYPICAL ELECTRICAL CHARACTERISTICS









FUNCTIONAL DESCRIPTION

The integrated circuit contains an internal voltage regulator that powers the Hall sensors and both the analog and digital circuitry. This regulator allows operation over a wide supply voltage range and provides some immunity to supply noise. The device also contains CMOS logic circuitry that decodes the direction of rotation of the ring magnet.

Quadrature/Direction Detection. Internal logic circuitry provides outputs representing speed and direction of the magnetic field across the face of the package. For the direction signal to be appropriately updated, a quadrature relationship must be maintained between the ring magnet pole width*, the sensor-to-sensor spacing, and, to a lesser extent, the magnetic switch points. For optimal design, the sensor should be actuated with a ring magnet pole width* two times the sensor-to-sensor spacing. This will produce a sinusoidal magnetic field whose period (denoted as T) is then four times the sensor-to-sensor spacing. A quadrature relationship can also be maintained for a ring magnet that has a period that satisfies the relationship nT/4 = 1.5 mm, where n is any odd integer. Therefore, ring magnets with pole-pair spacings equal to 6 mm (n = 1), 2 mm (n = 3), 1.2 mm (n = 5), etc. are permitted.

The response of the device to the magnetic field produced by a rotating ring magnet is shown on page 2. Note the phase shift between the two integrated sensors.

Outputs. The device provides three saturated outputs: DIRECTION, E1 OUTPUT, and SPEED. DIRECTION provides the direction output of the sensor and is defined as OFF (high) for the direction E1 to E2 and ON (low) for the direction E2 to E1. SPEED provides an XOR'd output of the two sensors. Because of internal delays, DIRECTION will always be updated before SPEED and is updated at every transition of E1 OUTPUT and E2 OUTPUT (internal) allowing the use of up-down counters without the loss of pulses.

Power-On State. At power on, the logic circutry is reset to provide an OFF (high) at DIRECTION and an OFF (high) for E1 and E2 (internal) for magnetic fields less than B_{OP} . This eliminates ambiguity when the device is powered up and either sensor detects a field between B_{OP} and B_{RP} . If either sensor is subjected to a field greater than B_{OP} , the internal logic will set accordingly.

* "Pole" refers to a single pole (North or South) unless stated as "pole pair" (North <u>and South</u>).

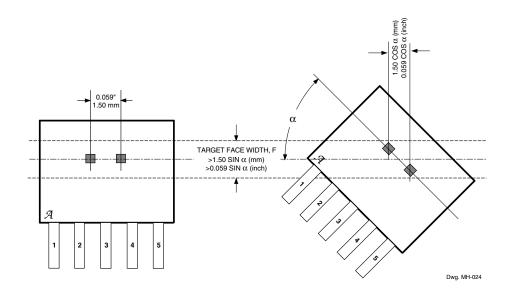
APPLICATIONS INFORMATION

Operation with Fine-Pitch Ring Magnets. For targets with a circular pitch of less than 4 mm, a performance improvement can be observed by rotating the front face of the sensor subassembly (see below). This sensor rotation decreases the effective sensor-to-sensor spacing, provided that the Hall elements are not rotated beyond the width of the target.

Applications. It is strongly recommended that an external $0.01~\mu F$ bypass capacitor be connected (in close proximity to the Hall sensor) between the supply and ground of the device to reduce both external noise and noise generated by the internal logic.

The simplest form of magnet that will operate these devices is a ring magnet. Other methods of operation, such as linear magnets, are possible. Extensive applications information on magnets and Hall-effect sensors is also available in the "Hsall-Effect IC Applications Guide" which can be found in the latest issue of the *Allegro MicroSystems Electronic Data Book*, AMS-702 or *Application Note* 27701, or at

www.allegromicro.com



Rotated sensor for fine-pitch ring magnets

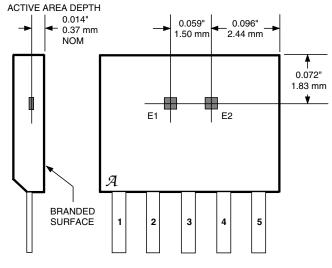
CRITERIA FOR DEVICE QUALIFICATION

All Allegro sensors are subjected to stringent qualification requirements prior to being released to production. To become qualified, except for the destructive ESD tests, no failures are permitted.

Qualification Test	Test Method and Test Conditions	Test Length	Samples Per Lot	Comments
Temperature Humidity Bias Life	JESD22-A101, T _A = 85°C, RH = 85%	1000 hrs	77	Device biased for minimum power
Bias Life	JESD22-A108, T _A = 150°C, T _J = 165°C	1000 hrs	77	
(Surge Operating Life)	JESD22-A108, T _A = 175°C, T _J = 190°C	1000 hrs	77	
Autoclave, Unbiased	JESD22-A102, T _A = 121°C, 15 psig	96 hrs	77	
High-Temperature (Bake) Storage Life	JESD22-A103, T _A = 170°C	1000 hrs	77	
Temperature Cycle	JESD22-A104	1000 cycles	77	-55°C to +150°C
ESD, Human Body Model	CDF-AEC-Q100-002	Pre/Post Reading	3 per test	Test to failure All leads > 8 kV

SENSOR LOCATIONS

(±0.005" [0.13 mm] die placement)

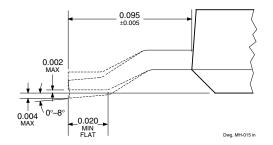


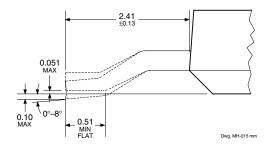
Dwg. MH-007-1

PACKAGE DESIGNATOR 'KA'

Dimensions in Millimeters Dimensions in Inches (controlling dimensions) (for reference only) 0.247 6.27 0.063 0.059 0.181 4.60 0.018 0.083 MAX 0.600 0.0138 SEE NOTE SEE NOTE 0.48 0.36 0.0189 0.0142 Dwg. MH-010H in Dwg. MH-010H mm

SURFACE-MOUNT LEAD FORM (add '-TL' to part number)





NOTES: 1. Tolerances on package height and width represent allowable mold offsets. Dimensions given are measured at the widest point (parting line).

- 2. Exact body and lead configuration at vendor's option within limits shown.
- 3. Height does not include mold gate flash.
- 4. Recommended minimum PWB hole diameter to clear transition area is 0.035" (0.89 mm).
- 5. Where no tolerance is specified, dimension is nominal.



HALL-EFFECT SENSORS

Partial Part	rt Avail. Oper. Characteristics at T _A = +25°C								
Number	Temp.	BOP max	BRP min	B _{hys} typ	Features	Notes			
RATIOMETRIC, LINEAR HALL-EFFECT SENSORS									
3503	S	t	yp. 1.3 mV/G)					
3507	E/L	t	yp. 2.5 mV/G	;					
3508	S	t	yp. 2.5 mV/G	;					
3515	E/L	t	yp. 5.0 mV/G	;	chopper stabilized				
3516	E/L	t	yp. 2.5 mV/G	;	chopper stabilized				
3517	L/S	t	yp. 5.0 mV/G	;	chopper stabilized				
3518	L/S	t	yp. 2.5 mV/G	ì	chopper stabilized				
GEA	RTOOTH/RIN	G MAGNET	DUAL ELEN	IENT) HALL-E	FFECT SENSORS in order of BOP				
3060	K/S	+35	-35	30	ac coupled				
3422	E/L	+75	-75	46	direction detection				
3059	K/S	+100	-100	130	ac coupled				
3056	E/L	+150	-150	50	zero-speed				
3058	E/L	+250	-250	200	zero-speed				
3421	E/L	+280	-280	335	direction detection				
	SPECIAL-PURPOSE HALL-EFFECT SENSORS								
3054	K/S	+300	+5.0	50	unipolar switch, multiplexed	4			
3209	Ε	±60	±5.0	7.7	400 μW, chopper stabilized				
3210	E E	±60	±5.0	7.7	25 μW, chopper stabilized				
3421	E/L	+280	-280	335	direction detection				
3422	E/L	+85	-85	46	direction detection				
3425	L	+24	-24	19	dual, chopper stabilized	1			

Operating Temperature Ranges: $S = -20^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $E = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $E = -40^{\circ}\text{C}$ to $+115^{\circ}\text{C}$, $E = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $E = -40^{\circ}\text{C}$ to $+150^{\circ}\text{C}$

Notes 1. Protected.

^{4.} Multiplexed two-wire sensor; after proper address, power/signal bus current indicates magnetic field condition.

The products described herein are manufactured under one or more of the following U.S. patents: 5,045,920; 5,264,783; 5,442,283; 5,389,889; 5,581,179; 5,517,112; 5,619,137; 5,621,319; 5,650,719; 5,686,894; 5,694,038; 5,729,130; 5,917,320; and other patents pending.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

Allegro products are not authorized for use as critical components in life-support appliances, devices, or systems without express written approval.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties that may result from its use.

